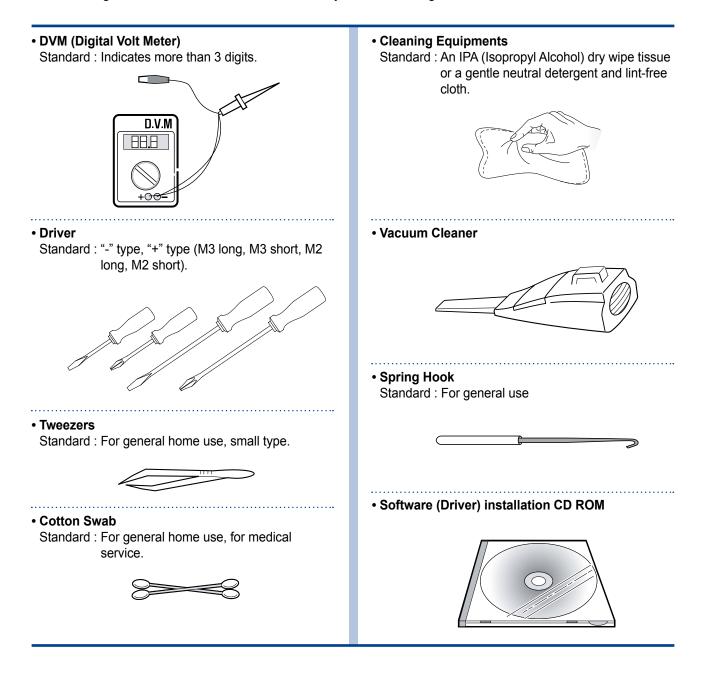
6. Reference Information

This chapter contains the tools list, list of abbreviations used in this manual, and a guide to the location space required when installing the printer. A definition of test pages and Wireless Network information definition is also included.

6.1 Tool for Troubleshooting

The following tools are recommended safe and easy troubleshooting as described in this service manual.



6.2 Acronyms and Abbreviations

The table below explains abbreviations used in this service manual. The contents of this service manual are declared with abbreviations in many parts. Please refer to the table.

6.2.1 Acronyms

ABS	Automatic Background Suppression(a	FDI	Foreign Device Interface
	kind of copy feature)	FIA	Foreign Interface Attachment
APF	Automatic Paper Feeder(Tray)	FRU	Field Replaceable Unit
BOOTP	BOOTSTRAP PROTOCOL	FPOT	First Print Out Time
CCD	Charged Coupled Device	GW	GateWay
CIS	Contact Image Sensor	HH	High Temperature, High Humidity
СРМ	Copies Per Minute	<u>.</u>	(Testing Chamber conditions)
СР	Control Panel(= OPE)	HPVC	Halftone Printing Video Controller in the
CQ	Copy Quality	.	SPGPm (Graphic Processor for Copy)
CRU	Customer Replaceable Unit	IDC	International Data Corp.
CRUM	CRU Memory	IMAP	Internet Message Access Protocol
CW	Center Ware	IPP	Internet Printing Protocols
CWDP	Center Ware Device Discovery	IPM	Images Per Minutes
	Software(Samsung equivalent of	IPX	Internetwork Packet Exchange
	Samsung's SyncThru)	IQ	Image Quality
CWIS	Center Ware Internet Services	ITU	International Telecommunication Union
DADF	Duplex Auto Document Feeder	JBIG	Joint Binary Image Group
	(= DADH)		(a kind of image data coding method)
DC	Direct Connect	JPEG	Joint Photographic Expert Group
DDNS	Dynamic Domain Name System	<u>.</u>	(a kind of image data coding method)
DHCP	Dynamic Host Configuration Protocol	LCD	Liquid Crystal Display
DLC	Data Link Control	LEF	Long Edge Feeding
DNS	Domain Name System	LL	Low Temperature, Low Humidity
ECM	Error Correction Mode	·····	(Testing Chamber conditions)
ECP	Enhanced Capability Port	LPR/LPD	Line Printer Daemon Protocols
e-Coil	Extended Coil technology for	<u>.</u>	(LPR is a TCP-based protocol)
	Rapid(Fast) Fusing.	LSU	Laser Scanning Unit
EH&S	Samsung Environment, Health,	LUI	Local User Interface
	& Safty	MCBF	Mean Copy Between Failure
ESMTP	Extended Simple Mail Transfer Protocol	MDSP	Multiple Document Single Printout
EP	Electro Photography	MFP	Multi-Functional Product
EPC	Electric Pre-Collation	MH	Modified Huffman
FCOT	First Copy Out Time		(a kind of image data coding method)

MIB	Management Information Base
MIME	Multipurpose Internet Mail Extensions
MR	Modified Read
	(a kind of image data coding method)
MMR	Modified and Modified Read
	(a kind of image data coding method)
MN std	Multi-National Standard
MSOK	Master SOK(System Operation Key)
MSO	Mixed Size Original
MP	Multi Purpose
MPBF	Mean Print Between Failure
MSI	Multi Sheet Input
MTBF	Mean Time Between Failure
MTTR	Mean Time To Repair
NCP	Network Control Protocol
NIC	Network Interface Card
NOS	Network Operating System
NN	Normal Temperature, Normal Humidity
NN	Normal Temperature, Normal Humidity (Testing Chamber conditions)
NN NSDR	
	(Testing Chamber conditions)
NSDR	(Testing Chamber conditions) Non-Shut Down Rate(=USDR)
NSDR NW	(Testing Chamber conditions) Non-Shut Down Rate(=USDR) Network
NSDR NW OD	(Testing Chamber conditions) Non-Shut Down Rate(=USDR) Network Optical Density
NSDR NW OD OHD	(Testing Chamber conditions) Non-Shut Down Rate(=USDR) Network Optical Density On Hook Dial
NSDR NW OD OHD OSOK	(Testing Chamber conditions) Non-Shut Down Rate(=USDR) Network Optical Density On Hook Dial Optional SOK(System Operation Key)
NSDR NW OD OHD OSOK OP	(Testing Chamber conditions) Non-Shut Down Rate(=USDR) Network Optical Density On Hook Dial Optional SOK(System Operation Key) Operational Procedure
NSDR NW OD OHD OSOK OP PCL	(Testing Chamber conditions) Non-Shut Down Rate(=USDR) Network Optical Density On Hook Dial Optional SOK(System Operation Key) Operational Procedure Printer Control Language
NSDR NW OD OHD OSOK OP PCL PDF	(Testing Chamber conditions) Non-Shut Down Rate(=USDR) Network Optical Density On Hook Dial Optional SOK(System Operation Key) Operational Procedure Printer Control Language (Adobe) Portable Document Format
NSDR NW OD OHD OSOK OP PCL PDF PPM	(Testing Chamber conditions) Non-Shut Down Rate(=USDR) Network Optical Density On Hook Dial Optional SOK(System Operation Key) Operational Procedure Printer Control Language (Adobe) Portable Document Format Pages Per Minutes
NSDR NW OD OHD OSOK OP PCL PDF PPM PQ	(Testing Chamber conditions) Non-Shut Down Rate(=USDR) Network Optical Density On Hook Dial Optional SOK(System Operation Key) Operational Procedure Printer Control Language (Adobe) Portable Document Format Pages Per Minutes Print Quality
NSDR NW OD OHD OSOK OP PCL PDF PPM PQ PS/3	(Testing Chamber conditions) Non-Shut Down Rate(=USDR) Network Optical Density On Hook Dial Optional SOK(System Operation Key) Operational Procedure Printer Control Language (Adobe) Portable Document Format Pages Per Minutes Print Quality PostScript Level-3
NSDR NW OD OHD OSOK OP PCL PDF PPM PQ PS/3	(Testing Chamber conditions) Non-Shut Down Rate(=USDR) Network Optical Density On Hook Dial Optional SOK(System Operation Key) Operational Procedure Printer Control Language (Adobe) Portable Document Format Pages Per Minutes Print Quality PostScript Level-3 Printing Video Controller in the
NSDR NW OD OHD OSOK OP PCL PDF PPM PQ PS/3 PVC	(Testing Chamber conditions) Non-Shut Down Rate(=USDR) Network Optical Density On Hook Dial Optional SOK(System Operation Key) Operational Procedure Printer Control Language (Adobe) Portable Document Format Pages Per Minutes Print Quality PostScript Level-3 Printing Video Controller in the SPGPm(Graphic Processor for Printer)

RT-OS	Real Time Operating System
RX	Receive
S2E	Scan-To-Email
SAD	Solid Area Density
SC	Service Call
SCF	Second Cassette Feeder
SDSP	Single Document Single Printout
SDMP	Single Document Multiple Printout
SDR	Shut Down Rate
SEF	Short Edge Feeding
SIR	Sacrified(or Standard) Image Reference
SOK	System Operation Key
sRGB	Standard RGB
	(Color Coordinate System)
SNMP	Simple Network Management Protocol
TCP/IP	Transmission Control Protocol/Internet
	Protocol
TBC(or tbc)	To Be Confirmed
TBD(or tbd)	To Be Determined
TIFF	(Adobe & Aldus) Tagged Image File
••••••	Format
TRIM	Technical Retrofit Interim Maintenance
TTM	Time to Market
TX	Transmit
UI	User Interface
UMC	Unit Manufacturing Cost
UMR	Unscheduled Maintenance Ratio
UPnP	Universal Plug and Play
USB	Universal Serial Bus
USDR	Un-Shut Down Rate(=NSDR)
XCMI	Samsung's Management Information
••••••	Base
WA	Base Warranty Action

6.2.2 Service Parts

ACRONYM	EXPLANATION
ELA HOU-SCANNER ASS'Y	ELA=Electrical Assembly, HOU =Housing
MEA UNIT-COVER PA EXIT ASS'Y	MEA= Mechanical Assembly, PA=Paper
PMO-TRAY EXTENTION MP NE	PMO= Processing Mold
	MP=Multi-Purpose(Bypass) tray
	NE=for NEC (common as Samsung Halk printer)
MEC-CASSETTE ASS'Y(LETTER)	MEC = Mechanic Combined unit
COVER-M-FRONT	M=Mold
MPR-NAME/PLATE	MPR= Machinery Press,
UNIT-LSU	LSU =Laser Scanning Unit
SMPS-SMPS(V1)+HVPS	SMPS =Switching Mode Power Supply
	HVPS =High Voltage Power Supply
ELA-OPC UNIT SET	OPC=Organic Photo-Conductive
ELA HOU-MP ASS'Y	MP =Multi-Purpose (Bypass) tray
PBA MAIN-MAIN	PBA =Printed circuit Board Assembly
PMO-CONNECT PAPER MFP	MFP =Multi-Functional Peripheral
FAN-DC	DC =Direct Current
CBF POWER STITCH GRAY	CBF= Cable Form
MEA UNIT GUIDE CST PA ASS'Y	CST=Cassette(Paper tray), PA=Paper
PBA LIU	PBA =Printed circuit Board Assembly
	LIU =Line Interface Unit for FAX
SHIELD-P_MAIN LOWER	P=Press
CBF HARNESS-LIU GND	LIU =Line Interface Unit for FAX
	GND= Ground
PMO-COVER FEED AY	AY=Assembly
PMO-COVER BRKT MOTER	BRKT=Bracket
CBF HARNESS-LSU	LSU =Laser Scanning Unit
IPR-SHIELD SMPS UPPERI	IPR=Iron Press
PMO-BUSHING P/U.MP	P/U=Pickup
	MP=Multi-Purpose (Bypass) Tray
PMO-HOLDER GEAR TRr	TR= Transfer Roller
SPRING ETC-TR_L	TR_L=Transfer Roller - Left
PMO-CAM JAM REMOVE	PMO-CAM= Processing Mold-CAM
PMO-LOCKER DEVE	DEVE=Developer

ACRONYM	EXPLANATION
SPECIAL SCREW(PANNEL MFP)	MFP =Multi-Functional Peripheral
A/S MATERAL-DUMMY UPPER ASS'Y	A/S=After-Service
MCT-GLASS ADF	MCT= Machinery Cutting
	ADF=Automatic Document Feeder
PPR-REGISTRATION EDGE(F)	PPR= Processing Press
IPR-HOLDER GLASSI	PR=Iron Press
MCT-GLASS SCANNER(LEGAL)	MCT= Machinery Cutting
CBF HARNESS-OPE	OPE=Operation Panel(Control Panel)
PBA SUB-D_SUB	PBA SUB-D_SUB =>Sub Printed circuit Board
	Assembly for the D-SUB type electrical connector
	(D-Sub) a kind of the connector type(shape 'D')
COVER-M-CCD CABLE	M=Mold
	CCD=Charge Coupled Device
COVER-SCAN LOWER(UMAX)	UMAX=> Supplier's name for CCD module
ICT-INSERT SHAFTI	ICT= Iron Cutting
IPR-BRK SCAN BD	IPR=Iron Press
	BRK=Bracket
	BD= Board
CBF SIGNAL-CCD FFC	CCD = Charge Coupled Device
	FFC =Flexible Flat Cable
COVER-M-OPE	M=Mold
	OPE=Operation Panel(Control Panel)
KEY-M-COPY	M=Mold
PLATE-M-ALPHA KEY	M=Molde
	ALPHA=Alphabet
PMO-GUIDE DP SIDE	DP=Duplex
RING-CS	CS= Compress
GEAR-MP/DUP DRV	MP =Multi-Purpose (Bypass) tray
	DUP DRV = Duplex Driver
IPR-BRKT G DUPI	PR=Iron Press
	BRKT=BRACKET
	G= Ground
	UP=Duplex
PMO-BUSHING TX(B4)	TX=Transmit
PMO-TRAY CASE, MP	MP=Multi-Purpose tray(Bypass tray)

ACRONYM	EXPLANATION
SPRING CS RE	CS=Compress
	RE=Rear
SPRING CS FR	CS=Compress
	FR=Front
PMO-BUSHING FINGER, F	F=Front
ICT-SHAFT-EXIT LOWER ID	ID=Idler
SPRING-EXIT ROLL FD	FD=Face Down
PMO-BUSHING_P/U,MP	P/U=Pickup
	MP =Multi-Purpose (Bypass) tray
PMO-HOLDER CAM MPF	MPF=Multi-Purpose Feeder(=MP)
PMO-GEAR P/U MPF	P/U=Pickup
MFP =Multi-Functional Peripheral	
RPR-RUBBER PICK UP,MP	RPR=Rubber Press
PBA SUB-MP SEN	PBA SUB-MP-SEN =>Sub Printed circuit Board
	Assembly for the MP-SEN(= Multi-Purpose (Bypass)
	tray-Sensor)
A/S MATERAL-PICKUP,MP	
FOOT-ML80	
HOLDER CATCH CST MC2	MC2=>McKInley2 (Samsung Project code name)
IPR-GROUND PLATE A(OPC)	OPC=Organic Photo-Conductive
ELA M/M-AUD SPEAKER	ELA M/M => Electrical Assembly M/M
	AUD=Audio
CBF HARNESS-OPC GND	OPC GNG=Organic Photo-Conductive-Ground
IPR-GROUND PLATE SCF	SCF=Second Cassette Feeder(Tray2)
PBA SUB-PTL	PBA SUB-PTL=>Sub Printed circuit Board Assembly
	for the PTL(= Pre Transfer Lamp)
PBA SUB-FEED+P.EMP SEN.	PBA SUB-FEED=>Sub Printed circuit Board
	Assembly for the feeder
	EMP SEN=Empty Sensor
MOTOR STEP-MCK2(MAIN)	
GEAR-EXIT/U	EXIT/U=EXIT/Upper
GEAR-RDCN FEED INNER	RDCN=Reduction
CBF-HARNESS-MAIN-THV WIRE	THV =Transfer High Voltage
CBF-HARNESS-MAIN-MHV WIRE	MHV= High Voltage(Charge Voltage)

ACRONYM	EXPLANATION
GEAR-EXIT/U,ID	U=Upper
	ID=Idler
IPR-TERMINAL FU	FU=Fuser
PMO-BEARING H/R-F	H/R-F=Heat Roller - Front
BEARING-H/R L	H/R-L=Heat Roller -Left
PEX-ROLLER EXIT F_UP	PEX= Processing Extrude
	F_UP=Face Up
SPRING ETC-P/R	P/R=Pressure Roller
SPRING(R)-CAU-HOT-FU	CAU-HOT-FU = Caution Hot -Fuser
PMO-ARM ACTUATOR	PMO-ARM= Processing Mold Arm
LABEL(R)-HV FUSER	HV=High Voltage (220V)
LABEL(R)-LV FUSER	LV=Low Voltage (110V)
PPR-SPONG SHEET	PPR=Plastic Press
IPR-P_PINCH(SCAN)I	PR-P = Iron Press
ROLLER-REGI	REGI=Registration
PBA SUB-REGI	PBA SUB-REGI => Sub Printed circuit Board
	Assembly for the Registration
GROUND-P_SCAN ROLLER	GROUND-P =Ground-Press
IPR-GUARD C/O S/W	C/O = Cover Open
	S/W= Switch
MEA UNIT-TX STACKER	TX =Transmit
IPR-WASHER SPRING CU	CU=Curve

6.3 The Sample Pattern for the Test

The sample pattern shown in below is the standard pattern used in the factory. The life of the toner cartridge and the printing speed are measured using the pattern shown below. (The image is 70% of the actual A4 size).

6.3.1 A4 ISO 19752 Standard Pattern

This test page is reproduced at 70% of the normal A4 size

A	NBCDEFGHIJKLMNOPQRSTUVWXYZ0123456789ABCDEFGHIJKLMNOPQRSTUVWX가 AB CO 면 대 요 관 문 문 문 문 문 문 문 문 문 대 ·················
	ABCDEFGHIJKLMNOPQRSTUVWXYZ0123456789ABCDEFGHIJKLMNOPQRSTUVWX
	23 January 2004
	Jonathan Q. Maderia
7501UZVX	Inpert Mampem Abaress 2343 Stantin Dawer Lank 867 Benhibe, SDF 767
15678	Mr.Maderia:
CONTRACTOR NAME AND A CONTRACT OF A CONT	Nam liber lempor cum soluta nobis eleifend pitor organization of the sequence of the sequen
LMNO	SJS:dwg P PINAL S
PQHS	
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6.4 Selecting a location

Select a level, stable place with adequate space for air circulation. Allow extra space for opening covers and trays.

The area should be well-ventilated and away from direct sunlight or sources of heat, cold, and humidity. Do not set the machine close to the edge of your desk or table.

Clearance space

- Front: 482.6 mm (enough space so that the paper tray can be removed)
- Back: 100 mm (enough space for ventilation)
- Right: 100 mm (enough space for ventilation)
- Left: 100 mm (enough space for ventilation)

